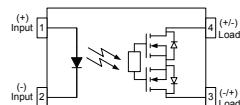
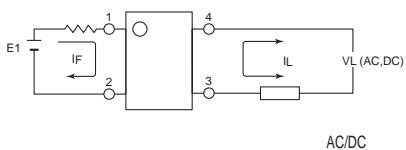


Parameter	Symbol	Rating	Units
Load Voltage	V_L	60	V
Load Current	I_L	0.5	A
On-Resistance	R_{on}	2	Ω
I/O Breakdown Voltage	V_{io}	5000	Vrms



1. LED Anode
2. LED Cathode
- 3.4. Drain(MOS FET)



E534710



SMD-4



DIP-4

APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power.

While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical lifetime)
- Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI
- No have voltaic arc, bounce, and noise
- More resistant to vibration and impact AC or DC load
- switching
- Small package size

Function

APSEMI Photorelays operate by taking a low level input current (<5mA) that energizes an input Infrared LED, which is optically-coupled to a Photo-diode array chip. This IC in turn generates a photo voltage that powers two MOSFETs typically connected in a source-to-source configuration, allowing for both AC and DC output loads. Photorelay basically move photons to accomplish their switching function, they incur no mechanical wear and tear, providing consistent reliable switching.

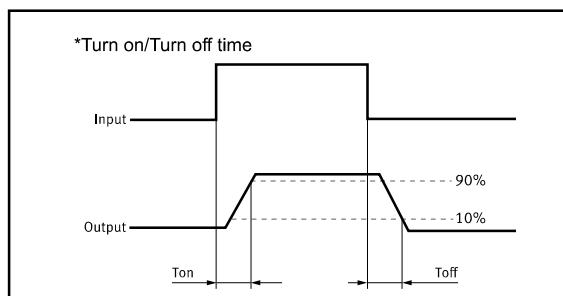
Applications

These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems
- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category	Output Rating		Package	Part No.	Packing Quantity	
	Load Voltage	Load Current				
AC/DC	60V	0.5		DIP-4	APY212GE	
				SMD-4	APY212GEH	



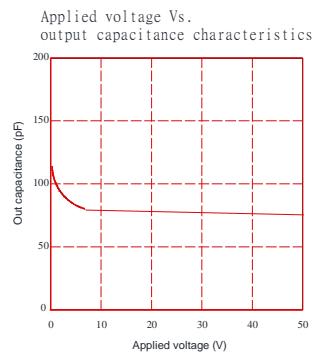
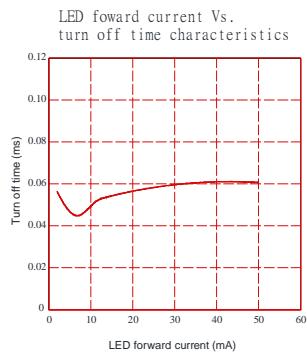
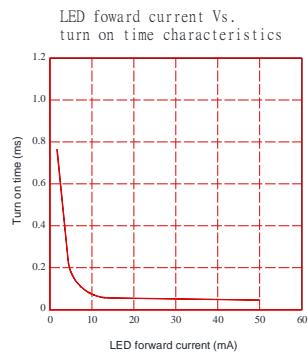
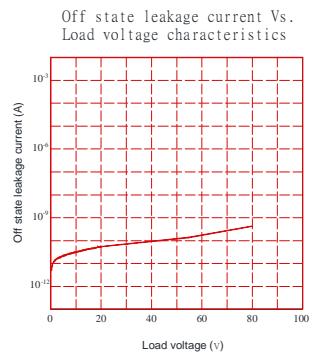
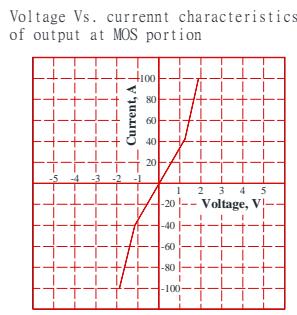
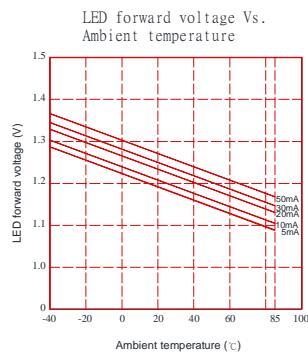
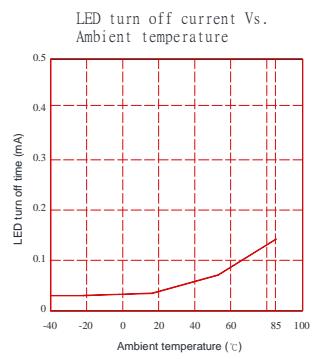
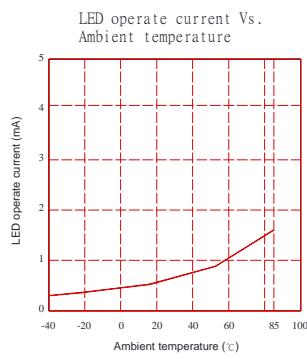
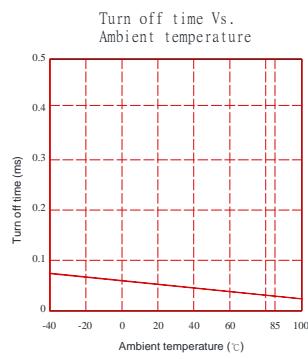
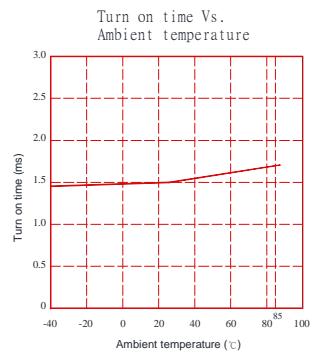
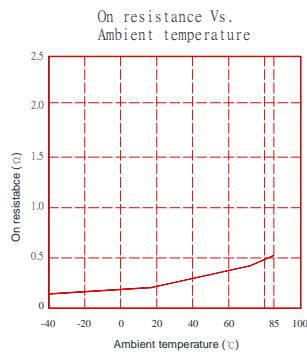
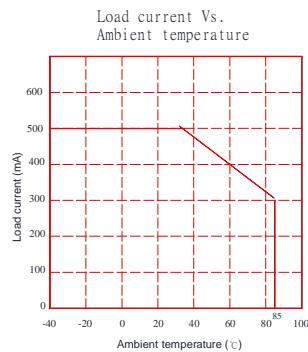
**Absolute Maximum Ratings (Ta = 25°C)**

Item		Symbol	Value	Units	Note
Input	Continuous LED Current	I _F	50	mA	
	Peak LED Current	I _{FP}	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	V _R	5	V	
	Input Power Dissipation	P _{In}	75	mW	
Output	Load Voltage	V _L	40	V(AC peak or DC)	
	Load Current	I _L	2.0	A	
	Peak Load Current	I _{Peak}	4.0	A	100ms(1 pulse)
	Output Power Dissipation	P _{out}	1.8	W	
Total Power Dissipation		P _T	2	W	
I/O Breakdown Voltage		V _{I/O}	5000	Vrms	RH=60%, 1min
Operating Temperature		T _{opr}	-40 to 85	°C	
Storage Temperature		T _{stg}	-40 to 100	°C	
Pin Soldering Temperature		T _{sol}	260	°C	10 sec max.

Electrical Characteristics (Ta = 25°C)

Item		Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	V _F		1.2	1.4	V	I _F =10mA
	Operation LED Current	I _{Fon}		0.5	3.0	mA	
	Recovery LED Current	I _{Foff}		0.35	0.5	mA	
	Recovery LED Voltage	V _{Foff}	0.5			V	
Output	On-Resistance	R _{on}		0.06	0.1	Ω	I _F =5mA, I _L =100mA, Time to flow is within 1 sec.
	Off-State Leakage Current	I _{Leak}	0.01	0.03	0.10	uA	V _L =Rating
	Output Capacitance	C _{out}		185		pF	V _L =0, f=1MHz
Transmission	Turn-On Time	T _{on}		0.8	1.5	ms	I _F =5mA, I _L =100mA,
	Turn-Off Time	T _{off}		0.02	0.5	ms	
Coupled	I/O Isolation Resistance	R _{I/O}	10 ¹⁰			Ω	DC500V
	I/O Capacitance	C _{I/O}		0.8	1.5	pF	f=1MHz

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

**Engineering Data**

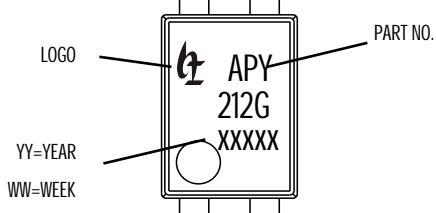


APSEMI

1 Form A APY212GE_EH
SMD-4/DIP-4 Load Voltage:60V Load Current:0.5A

Dimensions and DIP-4 Package Unit: mm

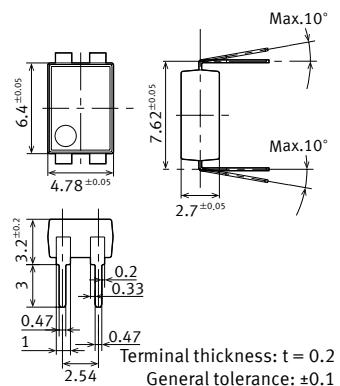
Marking



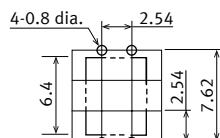
Label



Surface mount terminal type

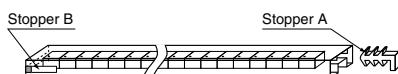


**PC board pattern
(BOTTOM VIEW)**



DIP Tape dimensions Unit : mm inch
Tolerance: +0.2 -.007

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.



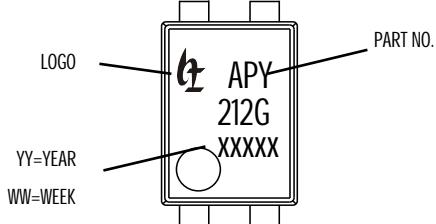


APSEMI

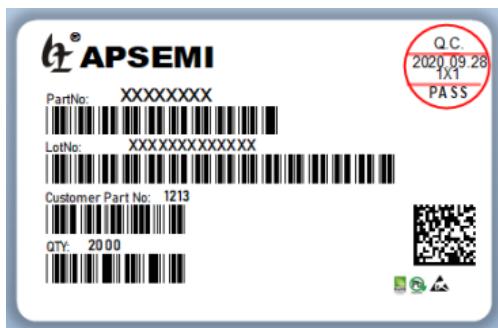
1 Form A APY212GE_EH
SMD-4/DIP-4 Load Voltage:60V Load Current:0.5A

Dimensions and SMD-4 Package Unit: mm

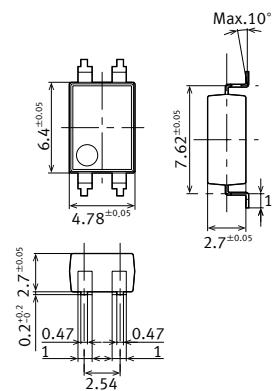
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Label



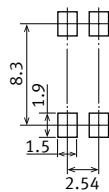
Surface mount terminal type



Terminal thickness: $t = 0.2$
General tolerance: ± 0.1

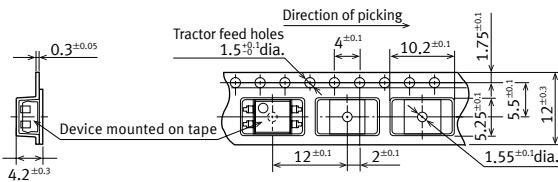
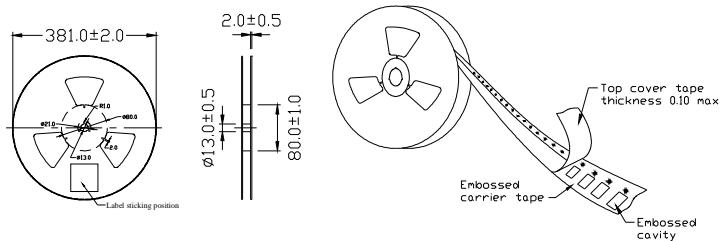
Recommended mounting pad

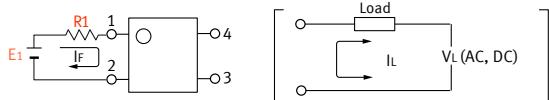
(TOP VIEW)



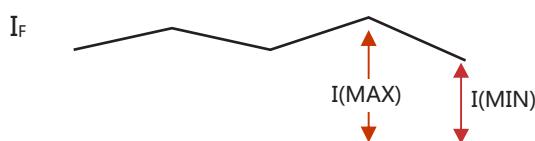
Tolerance: ± 0.1

Tape dimensions (tape reel)



**Using Methods**Examples of resistance value to control LED forward current ($I_F=5\text{mA}$)

E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9K Ω
24V	4.1K Ω

LED forward current must be more than 5mA , at $I(\text{MIN})$,and less than 30mA , at $I(\text{MAX})$.**Recommended Operating Conditions**

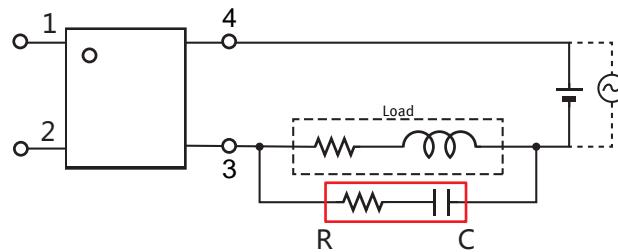
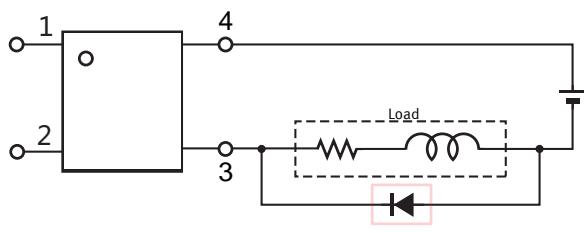
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

Characteristic	Symbol	Min	Typ.	Max	Unit
Forward current	I_F	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load.
Absorb capacity with external diode.

CR Snubber is connected in parallel with the load.
Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective.
Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.

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